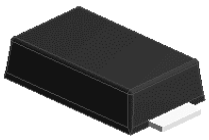
3A,20-40V Schottky Barrier Rectifier

Features

- Low leakage current
- Schottky barrier diode
- Low forward voltage drop
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260℃/10 seconds

RoHS
COMPLIANT



iSGA (SOD-123HS)

Applications

For use in low voltage, high frequency inverters, free-wheeling and polarity protection application.

Maximum Ratings & Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	PSL32	PSL33	PSL34	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	V
Maximum RMS voltage	V_{RMS}	14	21	28	V
Maximum DC blocking voltage	V_{DC}	20	30	40	V
Maximum average forward rectified current	$I_{F(AV)}$	3			A
Peak forward surge current,8.3ms single half sine-wave superimposed on rated load	I_{FSM}	80			A
Operating junction temperature range	T_J	-55 to +150			°C
Storage temperature range	T_{STG}	-55 to +150			°C

Thermal-Mechanical Specifications (T_A=25°C unless otherwise noted)

Parameter	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient	R_{thJA}	65	°C /W
Thermal Resistance, Junction to Case	R_{thJC}	35	°C /W
Thermal Resistance, Junction to Lead	R_{thJL}	9	°C /W

Electrical Specifications(T_A=25°C unless otherwise noted)						
Parameter	**Symbol**	**Test Conditions**	**PSL32**	**PSL33**	**PSL34**	**Unit**
Forward Drop Voltage	V_F	I_F=1A, T_A=25°C	0.40			V
		I_F=3A, T_A=25°C	0.45			
		I_F=3A, T_A=125°C	0.38			
Reverse leakage current @V_R	I_R	T_J =25°C	150			uA
		T_J =125°C	30			mA
Junction capacitance	C_J	V_R=4.0V, f=1MHZ	210			pF

Note：

1.The thermal resistance from junction to ambient or lead, mounted on copper pad area of 5.0 x 5.0mm to each terminal.

2.The thermal resistance from junction to case, mounted on recommended copper pad to each terminal.

Ratings and Characteristics Curves (TA=25°C unless otherwise noted)

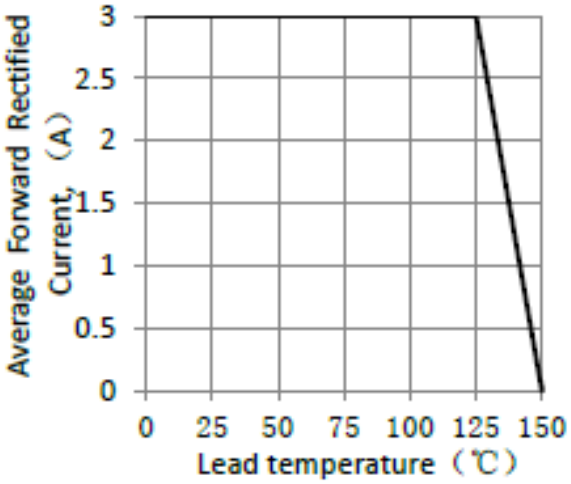


Figure 1.Forward Current Derating Curve

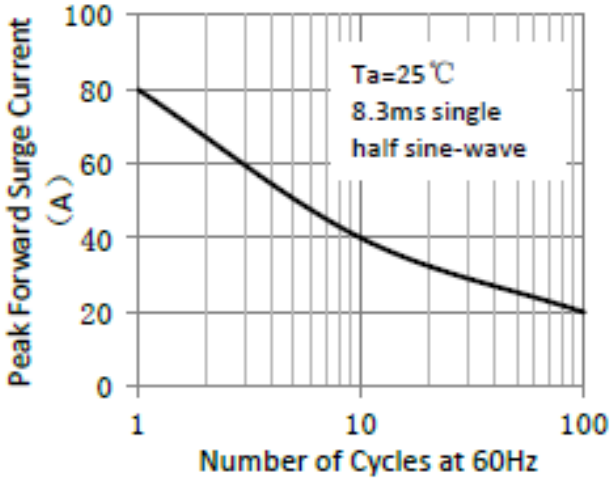


Figure 2.Maximum Non-Repetitive Peak Forward Surge Current

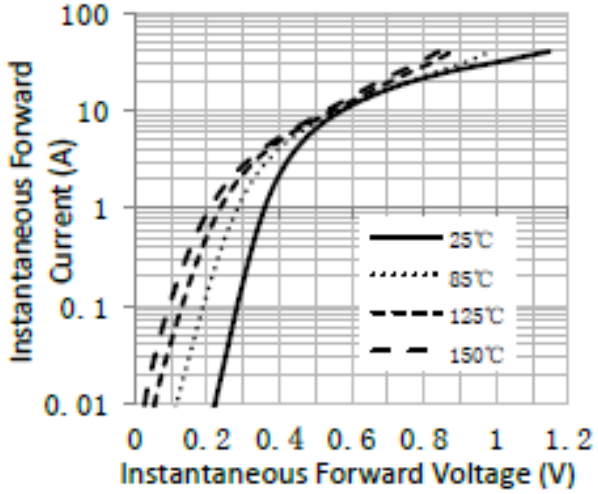


Figure 3. Typical Instantaneous Forward Characteristics

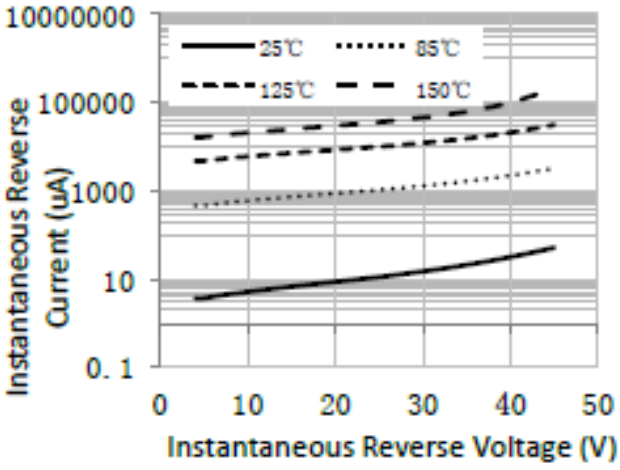


Figure 4. Typical Reverse Characteristics

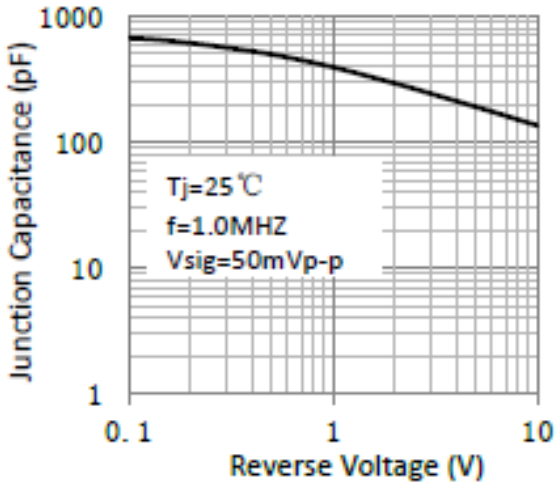
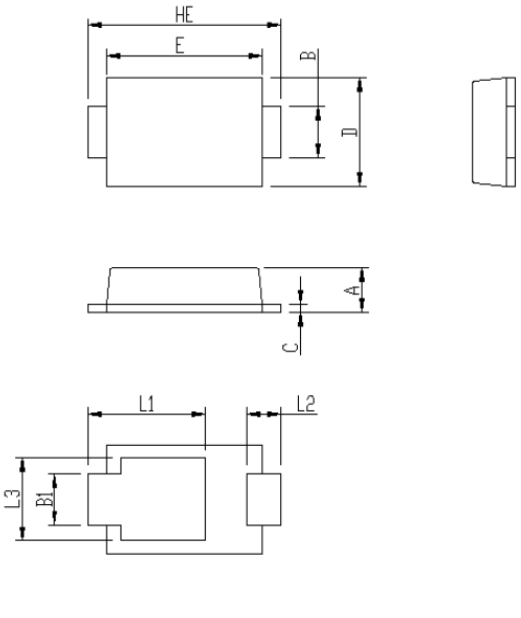


Figure 5. Typical Junction Capacitance

Package Outline Dimensions

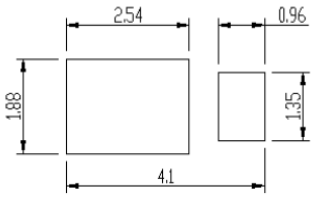
in millimeters

iSGA (SOD-123HS)



Package	iSGA	
Unit:mm	MIN	MAX
A	0.75	0.90
B	0.85	1.05
B1	0.85	1.05
C	0.1	0.25
D	1.9	2.1
E	2.9	3.1
L1	2.0	2.45
L2	0.4	0.85
L3	1.3	1.7
HE	3.5	3.9

Soldering footprint



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